



| Parameter | Rating | Units |
|-----------------------|--------|------------------|
| AC Operating Voltage | 120 | V_{rms} |
| Load Current | 1 | A _{rms} |
| On-State Voltage Drop | 1.2 | V_{rms} |
| $(I_L=1A_{rms})$ | | |

Features

- \bullet Load Current up to 1A_{rms} (3 A_{rms} with heat sink)
- Blocking Voltages up to 400V_P
- 5mA Sensitivity
- Zero-Crossing Detection
- · DC Control, AC Output
- · Optically Isolated
- TTL and CMOS Compatible
- Low EMI and RFI Generation
- High Noise Immunity
- VDE compatible
- · Machine Insertable, Wave Solderable

Applications

- Programmable Control
- Process Control
- Power Control Panels
- Remote Switching
- Gas Pump Electronics
- Contactors
- Large Relays
- Solenoids
- Motors
- Heaters

Description

The PS1201 is an AC Solid State Switch using optical coupling with dual power SCR outputs to produce an alternative to optocoupler and Triac circuits. The PS1201 switches are robust enough to provide a blocking voltage of up to 400V_P and max surge current rating of 20A. In addition, tightly controlled zero-cross circuitry ensures switching of AC loads without the generation of transients. The input and output circuits are optically coupled to provide 3750V_{rms} of isolation and noise immunity between control and load circuits. As a result the PS1201 is well suited for industrial environments where electromagnetic interference would disrupt the operation of electromechanical relays.

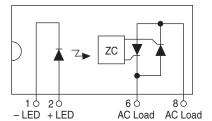
Approvals

- UL Recognized Component: UL 508 File E69938
- CSA Certified Component: Certificate LR43639-8

Ordering Information

| Part # | Description |
|--------|--|
| PS1201 | 4-Pin (8-Pin Body) SIP Package (25/Tube) |

Pin Configuration











Absolute Maximum Ratings @ 25°C

| Parameter | Min | Max | Units |
|--|------|------|------------------|
| Blocking Voltage | - | 400 | V _P |
| Reverse Input Voltage | - | 5 | V |
| Input Control Current | - | 100 | mA |
| Peak (10ms) | - | 1 | Α |
| Input Power Dissipation ¹ | - | 150 | mW |
| Total Package Dissipation ² | - | 1600 | mW |
| Isolation Voltage, Input to Output | 3750 | - | V _{rms} |
| Operational Temperature | -40 | +85 | °C |
| Storage Temperature | -40 | +125 | °C |

the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to

Electrical Characteristics @ 25°C

| Parameter | Conditions | Symbol | Min | Тур | Max | Units |
|---|-----------------------------------|-------------------|-------|------|-----|------------------|
| Output Characteristics | | | | | | |
| AC Operating Voltage | I _F =5mA | V _{OP} | 20 | - | 120 | V _{rms} |
| Load Current (Continuous) | V _L =120-240VAC | IL | 0.005 | - | 1 | A _{rms} |
| Maximum Surge Current | t≤16ms | I _{PEAK} | - | - | 20 | Α |
| Off-State Leakage Current | $V_L=400V_{DC}$ | I _{LEAK} | - | - | 1 | mA |
| On-State Voltage Drop | I _L =1A _{rms} | - | - | - | 1.2 | V _{rms} |
| Critical Rate of Rise | - | dV/dt | 1000 | 1200 | - | V/µs |
| Switching Speeds | | | | | | |
| Turn-On | I -EmA | t _{on} | - | - | 0.5 | Cycles |
| Turn-Off | I _F =5mA | t _{off} | - | - | 0.5 | Cycles |
| Zero-Cross Turn-On Voltage | 1st half-cycle | | - | 2 | 5 | V |
| | Subsequent half-cycle | - | - | - | 1 | V |
| Operating Frequency ¹ | - | - | 20 | - | 500 | Hz |
| Load Power Factor for Guaranteed Turn-On ² | - | PF | 0.25 | - | - | - |
| Capacitance Input-To-Output | - | C _{I/O} | - | 3 | - | pF |
| Input Characteristics | | | | | | |
| Input Control Current | | | | | | |
| For Normal Environment | - | ı | - | - | 5 | mA |
| For High Noise Environment | - IF | | - | - | 10 | |
| Input Voltage Drop | I _F =5mA | V _F | 0.9 | 1.2 | 1.4 | V |
| Input Dropout Voltage | - | - | 0.8 | - | - | V |
| Reverse Input Current | V _R =5V | I _R | - | - | 10 | μΑ |

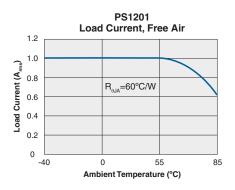
¹ Derate Linearly 1.33 mW / °C

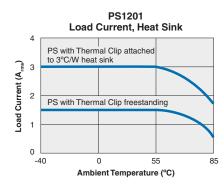
² Derate Linearly 16.6 mW / °C

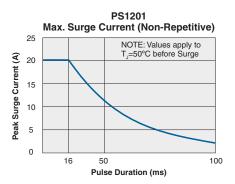
Zero Cross 1st half-cycle @ < 100Hz.
Snubber circuits may be required at low power factors.

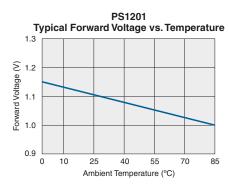


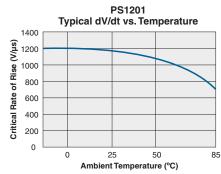
PERFORMANCE DATA*

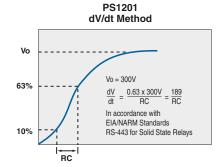












^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to

the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device | Moisture Sensitivity Level (MSL) Rating |
|--------|---|
| PS1201 | MSL 1 |

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

| Device | Maximum Temperature x Time |
|--------|----------------------------|
| PS1201 | 245°C for 30 seconds |

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.







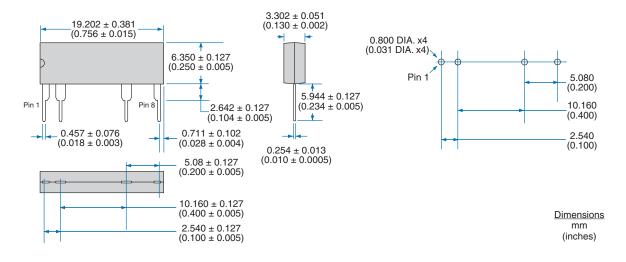


MECHANICAL DIMENSIONS

PS1201

4-Lead, 8-Pin, SIP Package

Recommended PCB Hole Pattern



For additional information please visit our website at: www.clare.com

Clare, Inc. makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in Clare's Standard Terms and Conditions of Sale, Clare, Inc. assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of Clare's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. Clare, Inc. reserves the right to discontinue or make changes to its products at any time without notice.